

Record of Letter Ballot Review by TC Chapter for Procedural Review

Region/Locale: [Europe](#)

Global Technical Committee: [Silicon Wafer](#)

TC Chapter Cochairs: [Fritz Passek \(Siltronic\)](#), [Peter Wagner \(Self\)](#), [Werner Bergholz \(Jacobs University\)](#)

Standards Staff: [Laura Nguyen](#)

	Scheduled in Background Statement	Actual
Date	11/14/2024	11/14/2024
Location	ICM, Munich, Germany	ICM, Munich, Germany
Reason for Change of Date and/or Location (if changed)		

Note: See *Regulations* ¶ 9.5 Exceptions for allowable reason to change.

I. Document Number and Title

Document Number	Document Title
7261	Reapproval of SEMI M53-0220 Practice for Calibrating Scanning Surface Inspection Systems Using Certified Depositions of Monodisperse Reference Spheres on Unpatterned Semiconductor Wafer Surfaces

II. Tally

Standards staff to fill in.

Voting Tally: **As-cast tally after close of voting period**

Note: A minimum of 60% of the Voting Interests that have TC Members within the global technical committee that issued the Letter Ballot must return Votes. (*Regulations* ¶ 9.6.2.1.1)

Voting Tally:

Voting Interest:	Returned Votes	Distribution	Return Rate	
Letter Ballot	64	÷ 105	= 61.0%	≥60%
Intercommittee Ballot	30			
Voting Interest Reject(s)	0	Total Voters with Rejects		0
Voting Interest Accept(s)	64			

Note: See *Regulations* § 3.2.1 for definition of Voting Interest.

VIII. Safety Check

Note: See *Regulations § 15* for further information.

Motion	<input checked="" type="checkbox"/>	This is not a Safety Document , when all safety-related information is removed, the Document is still technically sound and complete. (<i>Regulations ¶ 8.7.1</i>)
	<input type="checkbox"/>	This is a Safety Document , when all safety-related information is removed, the Document is not technically sound and complete. (<i>Regulations ¶ 8.7.2</i>)
	<input type="checkbox"/>	Safety Checklist (<i>Regulations ¶ 15.3</i>) is complete and has been included with the Document throughout the balloting process. (<i>Regulations ¶ 15.1.2</i>)
Motion by/2 nd by		By: Kurt Haller / KLA-Tencor Second: Maria Cristina Sanna / GlobalWafers Company
Discussion		None
Vote		6 Y 0 N; Motion passed or

IX. Intellectual Property (IP) Check

Note: This Letter Ballot may cover all or part of a Standard or Safety Guideline. Regardless of the coverage, this IP check applies to the entire Standard or Safety Guideline*. See *Regulations § 16* for further information.

<input checked="" type="checkbox"/>	The TC Chapter meeting chair asked those participating, if they were aware of any patented technology that might be relevant (see <i>Regulations ¶ 16.3.1.1</i>) to the Standard or Safety Guideline; or, any copyrighted items or trademarks that are used/reproduced (see <i>Regulations ¶ 16.4.1.2</i>) in the Standard or Safety Guideline. (Also see, <i>Regulations § 8.8</i>)	
<input checked="" type="checkbox"/>	The question is NOT answered in affirmative (No potentially material patented technology or use/reproduction of copyrighted items/trademarks is known.)	GO TO SECTION X.

X. Action for This Document

Motion	<input checked="" type="checkbox"/>	This Document passed TC Chapter review as balloted and will be forwarded to the ISC A&R SC for procedural review.
Motion by/ 2 nd by		By: Kurt Haller / KLA-Tencor Second: Frank Riedel / Siltronic AG
Discussion		None
Vote		6 Y 0 N
Final Action		<input checked="" type="checkbox"/> Motion passed
		<input type="checkbox"/> Motion failed

Note: If the use of PMPT or copyrighted item is justified by the TC Chapter, LOA or release form must be received before publication can proceed.